



Product Change Notification

Change Notification #: 116480 - 00
Change Title: Intel® Server System R1208WT2GSR,
Intel® Server System R1208WTTGSR,
PCN 116480-00, Product Design,
Update bracket design on AXXRMFBU
Date of Publication: September 11, 2018

Key Characteristics of the Change:
Product Design

Forecasted Key Milestones:

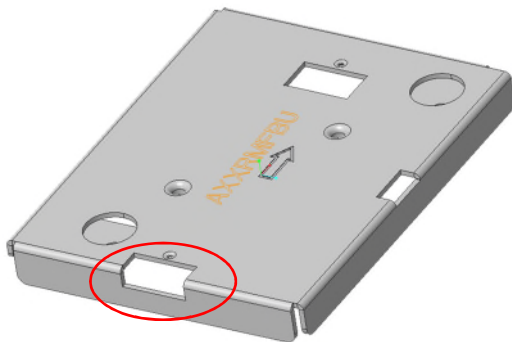
Date Customer Must be Ready to Receive Post-Conversion Material: *	October 9, 2018
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** Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

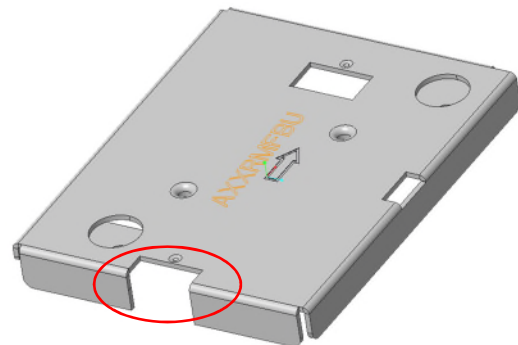
Description of Change to the Customer:

Intel® Server Systems listed in the "products affected" table are being affected by the following update.

1. The metallic bracket used on the Intel® RAID Maintenance Free Backup "AXXRMFBU" is changing to prevent interference when the plastic bracket it is being removed.



Before change



After Change

Customer Impact of Change and Recommended Action:

Intel recommend to the customers to perform a fit check on their systems and chassis based on this new design.

Contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
R1208WT2GSR	975756	J11465-012	J11465-013
R1208WTTGSR	977047	J11481-014	J11481-015

PCN Revision History:

Date of Revision:
September 11, 2018

Revision Number:
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Reason:
Originally Published PCN



Product Change Notification

116480 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apagccb@intel.com

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